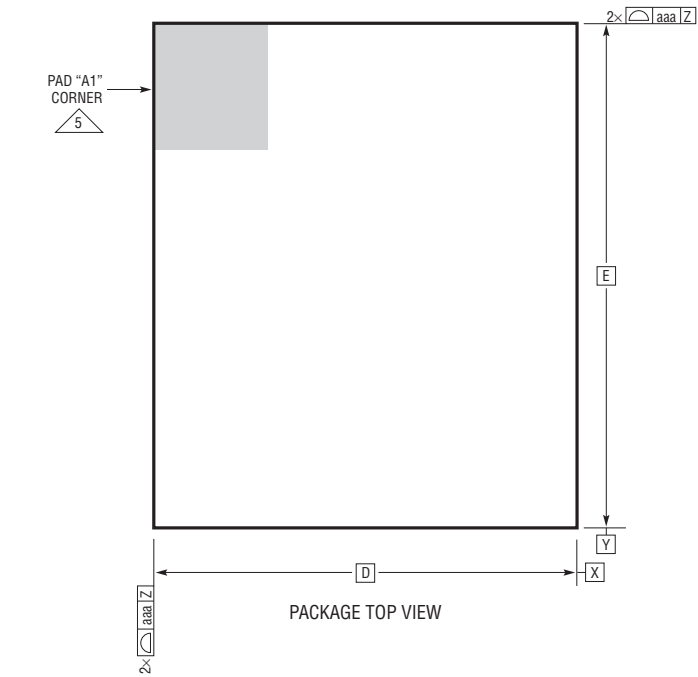
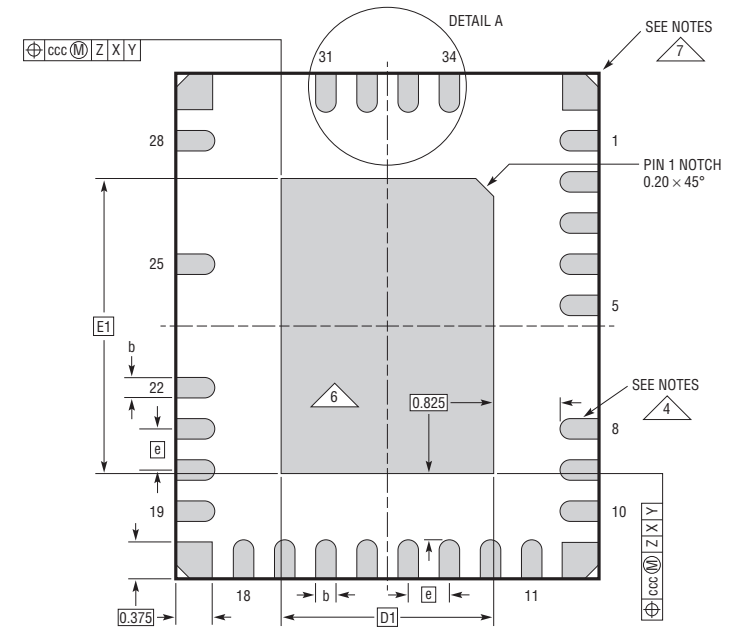
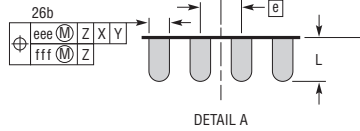
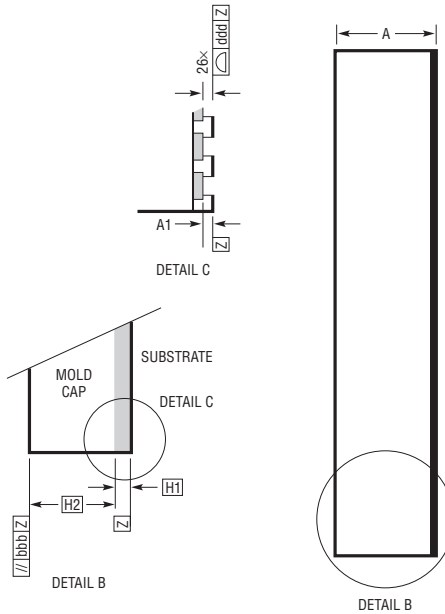


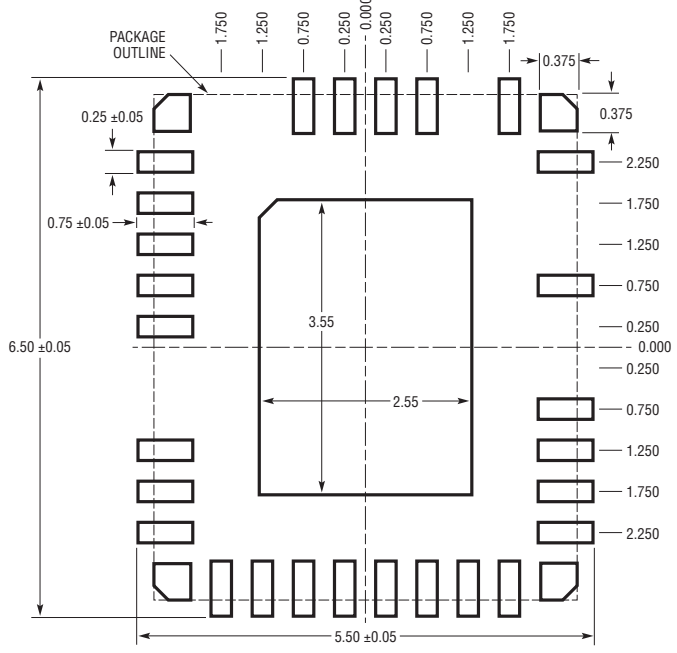
**LQFN Package**  
**36 (26)-Lead with 10 Pins Removed (6mm × 5mm × 1.40mm)**  
 (Reference LTC DWG # 05-08-1619 Rev 0)



PACKAGE TOP VIEW



PACKAGE BOTTOM VIEW

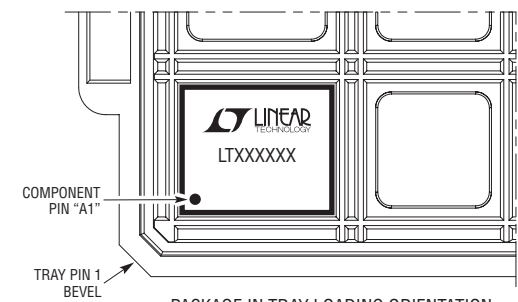


SUGGESTED PCB LAYOUT TOP VIEW

DIMENSIONS				
SYMBOL	MIN	NOM	MAX	NOTES
A	1.30	1.40	1.50	
A1	0.02	0.03	0.04	
L	0.30	0.40	0.50	
b	0.22	0.25	0.28	
D		5.00		
E		6.00		
D1		2.55		
E1		3.55		
e		0.50		
H1		0.20		SUBSTRATE THK
H2		1.20		MOLD CAP HT
aaa			0.10	
bbb			0.10	
ccc			0.10	
ddd			0.10	
eee			0.15	
fff			0.08	

- NOTES:
- DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994
  - ALL DIMENSIONS ARE IN MILLIMETERS
  - PRIMARY DATUM -Z- IS SEATING PLANE

- 4 METAL FEATURES UNDER THE SOLDER MASK OPENING NOT SHOWN SO AS NOT TO OBSCURE THESE TERMINALS AND HEAT FEATURES
- 5 DETAILS OF PAD #1 IDENTIFIER ARE OPTIONAL, BUT MUST BE LOCATED WITHIN THE ZONE INDICATED. THE PAD #1 IDENTIFIER MAY BE EITHER A MOLD OR MARKED FEATURE
- 6 THE EXPOSED HEAT FEATURE MAY HAVE OPTIONAL CORNER RADII
- 7 CORNER SUPPORT PAD CHAMFER IS OPTIONAL



PACKAGE IN TRAY LOADING ORIENTATION